

NCE N-Channel Super Trench II Power MOSFET

Description

The series of devices uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

Application

- DC/DC Converter
- •Ideal for high-frequency switching and synchronous rectification

General Features

- V_{DS} =100V, I_{D} =123A $R_{DS(ON)}$ =4.0m Ω , typical @ V_{GS} =10V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating

100% UIS TESTED! 100% ΔVds TESTED!

TO-263-2L





Schematic Diagram

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP050N10MD	NCEP050N10MD	TO-263-2L	-	-	-

Absolute Maximum Ratings (T_c=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	100	V
Gate-Source Voltage	V _G s	±20	V
Drain Current-Continuous	I _D	123	А
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	100	Α
Pulsed Drain Current	I _{DM}	492	Α
Maximum Power Dissipation	P _D	200	W
Derating factor		1.33	W/℃
Single pulse avalanche energy (Note 1)	E _{AS}	980	mJ
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 175	$^{\circ}$

Thermal Characteristic

Thermal Resistance,Junction-to-Case	Rejc	0.75	°C/W
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Electrical Characteristics (Tc=25 $^{\circ}$ C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	100		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics				•		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2.0	3.0	4.0	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =20A	-	4.0	5.0	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =20A		60	-	S
Dynamic Characteristics						
Input Capacitance	Clss	\/ F0\/\/ 0\/	-	6550	-	PF
Output Capacitance	Coss	$V_{DS}=50V, V_{GS}=0V,$	-	540	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	45	-	PF
Switching Characteristics (Note 2)						
Turn-on Delay Time	t _{d(on)}		-	26	-	nS
Turn-on Rise Time	t _r	V_{DD} =50 V , I_D =20 A	-	61	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{G} =1.6 Ω	-	50	-	nS
Turn-Off Fall Time	t _f		-	48	-	nS
Total Gate Charge	Qg	\/ F0\/ 00A	-	106	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =50V,I _D =20A,	-	31.5		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	28		nC
Drain-Source Diode Characteristics				•		
Diode Forward Voltage	V _{SD}	V _{GS} =0V,I _S =20A	-		1.2	V
Diode Forward Current	Is		-	-	123	Α
Reverse Recovery Time	t _{rr}	$T_J = 25^{\circ}C, I_F = I_S$	-	80	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs	-	170	-	nC

Notes:

- 1. EAS condition : Tj=25 $^{\circ}\text{C}$,VDD=50V,VG=10V,L=0.5mH,Rg=25 Ω
- 2. Guaranteed by design, not subject to production
- 3. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of TJ(MAX)=175° C. The SOA curve provides a single pulse rating.



Typical Electrical and Thermal Characteristics

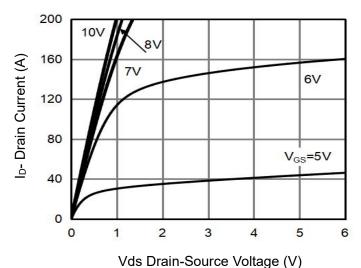
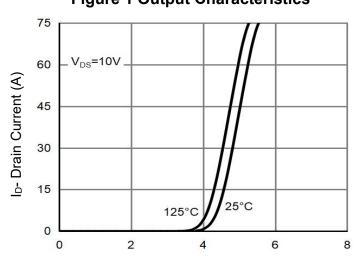


Figure 1 Output Characteristics



Vgs Gate-Source Voltage (V)
Figure 2 Transfer Characteristics

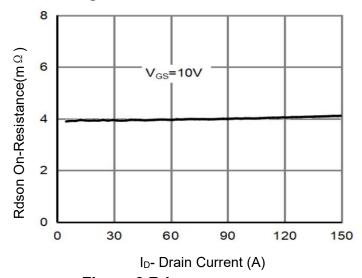


Figure 3 Rdson- Drain Current

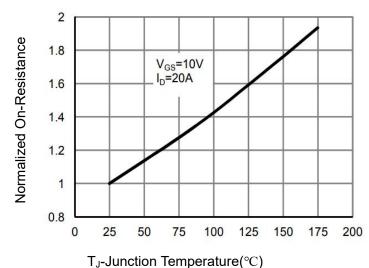


Figure 4 Rdson-Junction Temperature

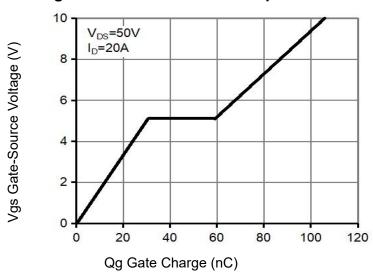


Figure 5 Gate Charge

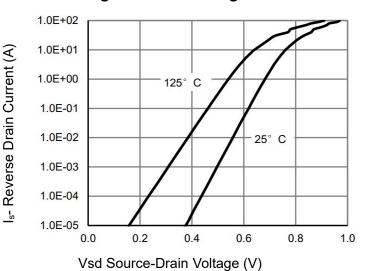
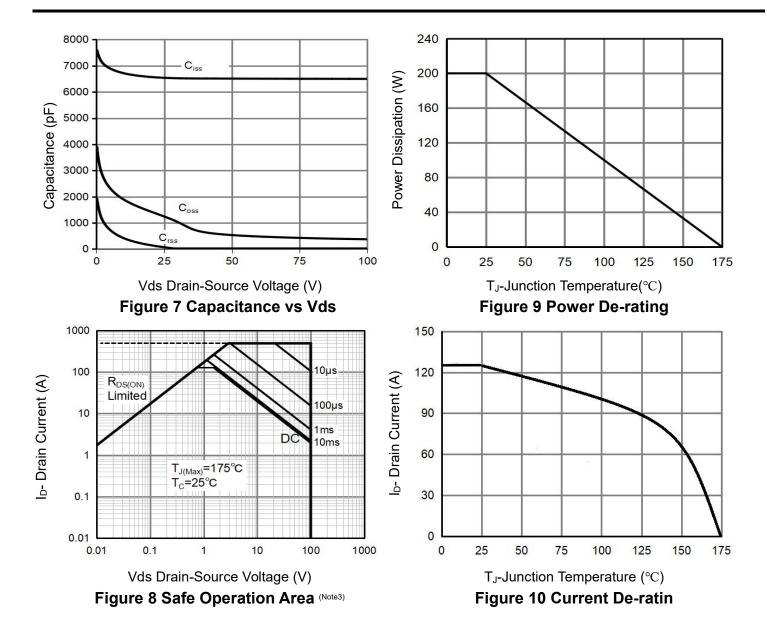
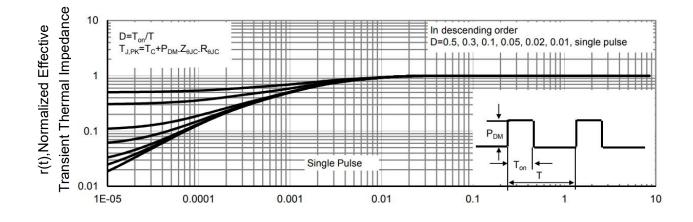


Figure 6 Source- Drain Diode Forward





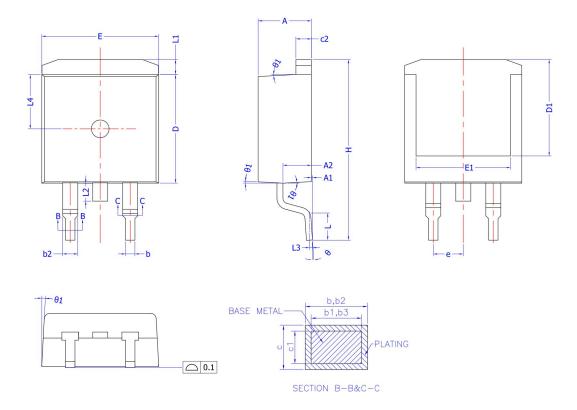


Square Wave Pluse Duration(sec) Figure 11 Normalized Maximum Transient Thermal Impedance

V1.0



TO-263-2L Package Information



COMMON DIMENSIONS
(UNITS OF MEASURE =MILLIMETER)

SYMBOL	MIN NOM		MAX		
A	4.40	4.50	4.60		
A1	0	0.10	0.25		
A2	2.20	2.40	2.60		
b	0.76		0.89		
b1	0.75	0.80	0.85		
b2	1.23		1.37		
b3	1.22	1.27	1.32		
С	0.47		0.60		
c1	0.46	0.51	0.56		
c2	1.25	1.30	1.35		
D	9.10	9.20	9.30		
D1	8.00				
E	9.80	9.90	10.00		
E1	7.80				
е	2.	2.54 BSC			
Н	14.90	15.30	15.70		
L	2.00	2.30	2.60		
L1	1.17	1.27	1.40		
L2		1 - T	1.75		
L3	0.25BSC 4.60 REF				
L4					
θ	0°	8°			
θ1	1°	3°	5°		



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